

TSOP752.., TSOP754..

Vishay Semiconductors

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RoHS

COMPLIANT

HALOGEN FREE

GREEN

(5-2008)

IR Receiver Modules for Remote Control Systems





LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

This IR receiver series is optimized for long burst remote control systems in different environments. The customer can chose between different IC settings (AGC variants), to find the optimum solution for his application. The higher the AGC, the better noise is suppressed, but the lower the code compatibility.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding. These components have not been qualified to automotive specifications.

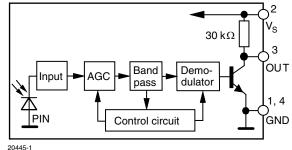
FEATURES

- Individual IC settings to reach maximum performance
- Immunity against noise (lamps, LCD TV, Wi-Fi)
- Low supply current
- · Photo detector and preamplifier in one package
- Supply voltage: 2.0 V to 5.5 V
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESIGN SUPPORT TOOLS

- 3D models
- Window size calculator

BLOCK DIAGRAM



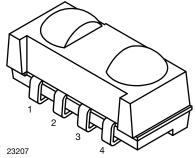


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MECHANICAL DATA

Pinning:

1, 4 = GND, 2 = V_S , 3 = OUT

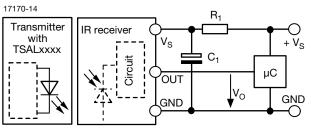


ORDERING CODE

Taping:

TSOP75...TT - top view taped, 2200 pcs/reel TSOP75...TR - side view taped, 2300 pcs/reel

APPLICATION CIRCUIT



 $\rm R_1$ and $\rm C_1$ recommended in case there are strong ripple or spikes on the supply line.

PARTS TABLE					
AGC		LEGACY, FOR LONG BURST REMOTE CONTROLS (AGC2)	RECOMMENDED FOR LONG BURST CODES (AGC4)		
Carrier frequency	30 kHz	TSOP75230	TSOP75430		
	33 kHz	TSOP75233	TSOP75433		
	36 kHz	TSOP75236	TSOP75436 ⁽¹⁾⁽²⁾⁽³⁾		
	38 kHz	TSOP75238	TSOP75438 ⁽⁴⁾⁽⁵⁾⁽⁶⁾		
	40 kHz	TSOP75240	TSOP75440		
	56 kHz	TSOP75256	TSOP75456 ⁽⁷⁾		
Package		Heimdall			
Pinning		1, 4 = GND, 2 = V _S , 3 = OUT			
Dimensions (mm)		6.8 W x 3.0 H x 3.2 D			
Mounting		SMD			
Application		Remote control			
Best choice for		⁽¹⁾ RC-5 ⁽²⁾ RC-6 ⁽³⁾ Panasonic ⁽⁴⁾ NEC ⁽⁵⁾ Sharp ⁽⁶⁾ Mitsubishi ⁽⁷⁾ Thomson RCA			
Special options		 Extended temperature range: <u>www.vishay.com/doc?82738</u> Narrow optical filter: <u>www.vishay.com/doc?81590</u> Wide optical filter: <u>www.vishay.com/doc?82726</u> 			

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +6.0	V
Supply current		IS	3	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		lo	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

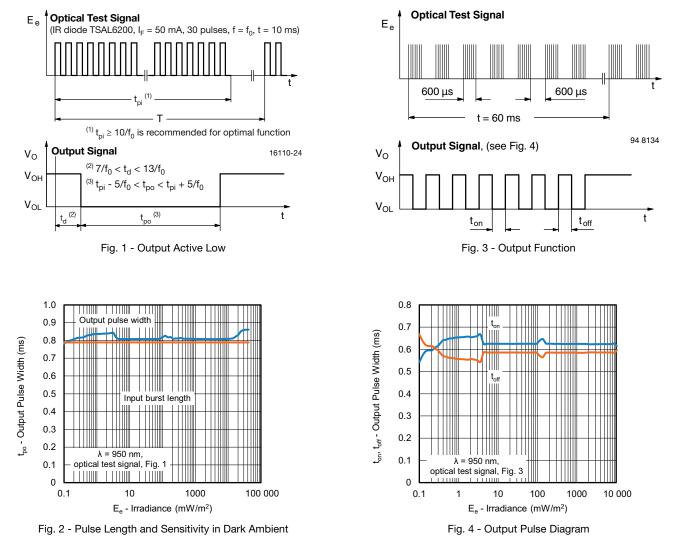


TSOP752.., TSOP754..

Vishay Semiconductors

ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.0	-	5.5	V
Supply current	$E_v = 0, V_S = 3.3 V$	I _{SD}	0.25	0.35	0.45	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}	-	0.45	-	mA
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, I _F = 50 mA	d	-	26	-	m
Output voltage low	I_{OSL} = 0.5 mA, E _e = 0.7 mW/m ² , test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Test signal: RC5 code	E _{e min.}	-	0.1	0.2	mW/m ²
Minimum madiance	Test signal: NEC code	E _{e min.}	-	0.13	0.25	mW/m ²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 5/f _o , test signal see Fig. 1	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	φ1/2	-	± 50	-	0

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



Rev. 2.3, 17-May-2024



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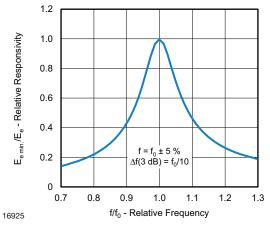
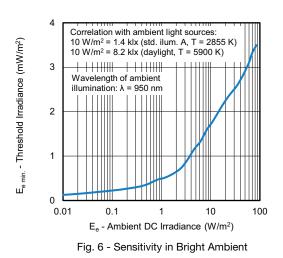


Fig. 5 - Frequency Dependence of Responsivity



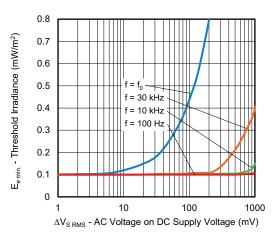


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

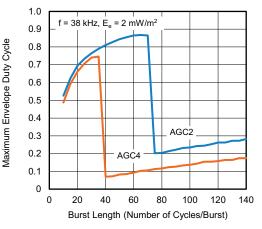


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

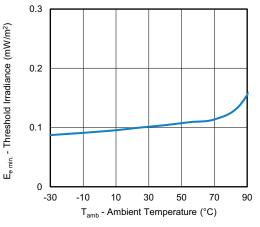


Fig. 9 - Sensitivity vs. Ambient Temperature

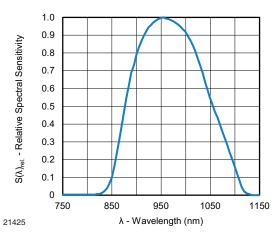


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

Rev. 2.3, 17-May-2024

4

Document Number: 82494

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Datasheet Values Refer to PCN-OPT-1308-2024



TSOP752.., TSOP754..

Vishay Semiconductors

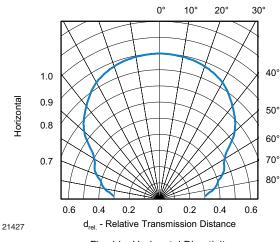
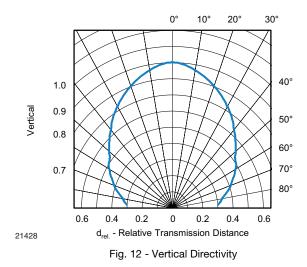


Fig. 11 - Horizontal Directivity



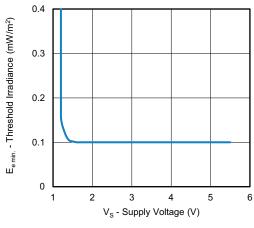


Fig. 13 - Sensitivity vs. Supply Voltage

Rev. 2.3, 17-May-2024

Datasheet Values Refer to PCN-OPT-1308-2024



TSOP752.., TSOP754..

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SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output.

Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 14 or Fig. 15)

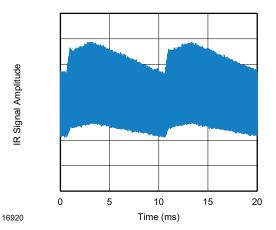


Fig. 14 - IR Disturbance from Fluorescent Lamp With Low Modulation

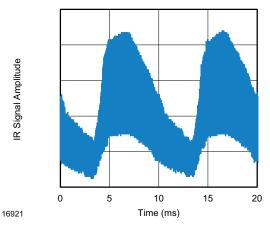


Fig. 15 - IR Disturbance from Fluorescent Lamp With High Modulation

	TSOP752	TSOP754
Minimum burst length	10 cycles/burst	10 cycles/burst
After each burst of length a minimum gap time is required of	10 to 70 cycles ≥ 12 cycles	10 to 35 cycles ≥ 12 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 5 x burst length	35 cycles > 15 x burst length
Maximum number of continuous short bursts/second	1700	1700
NEC code	Yes	Preferred
RC5 / RC6 code	Yes	Preferred
Thomson RCA 56 kHz code	Yes	Preferred
Sharp code	Yes	Preferred
Panasonic code	Yes	Preferred
Sony code	Yes	No
Mitsubishi code	Yes	Preferred
Suppression of interference from fluorescent lamps	Fig. 14	Fig. 14 and Fig. 15

Notes

• For data formats with short bursts please see the datasheet for TSOP753.., TSOP755..

For Sony 12, 15, and 20 bit IR codes please see the datasheet of TSOP75S40F

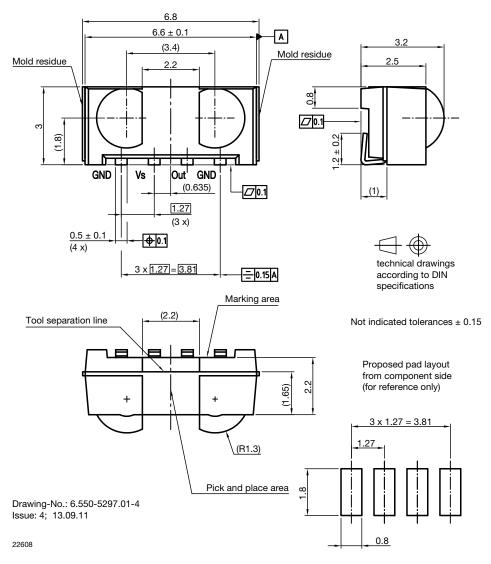
Rev. 2.3, 17-May-2024



TSOP752.., TSOP754..

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PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

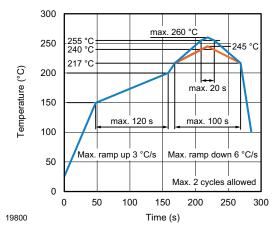
- \bullet Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 $^\circ C$
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

Rev. 2.3, 17-May-2024

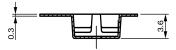


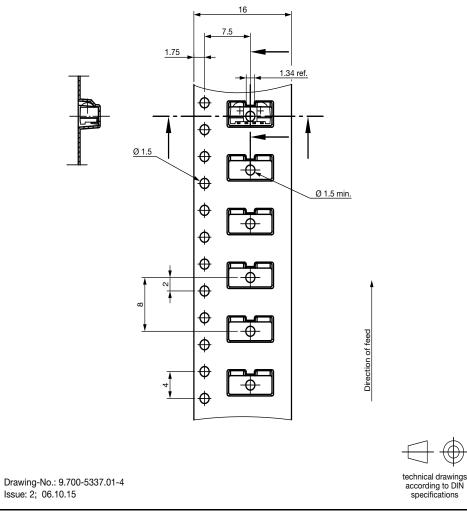
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VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TR DIMENSIONS in millimeters





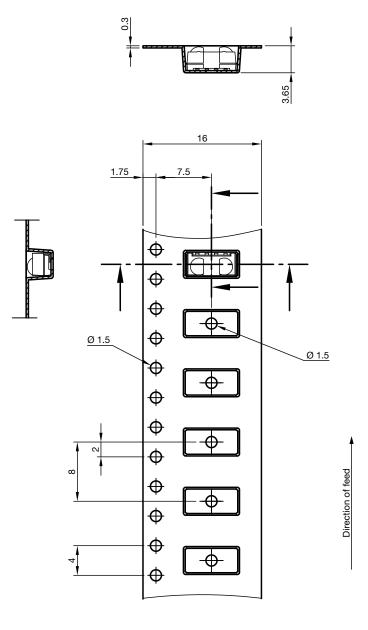
Rev. 2.3, 17-May-2024

Document Number: 82494



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TAPING VERSION TSOP..TT DIMENSIONS in millimeters





technical drawings according to DIN specifications

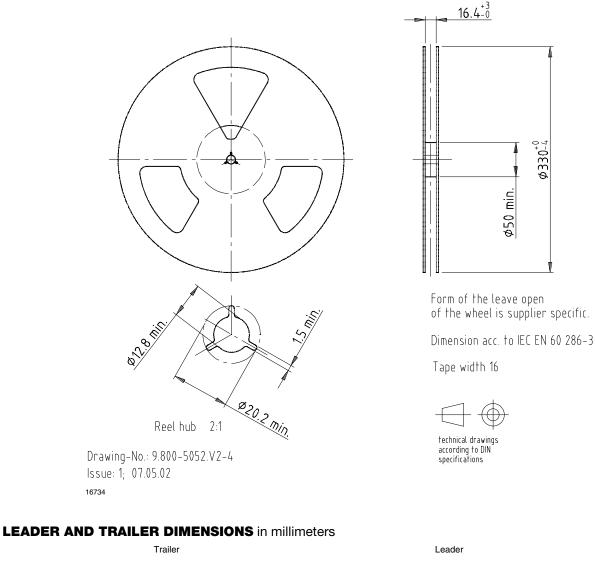
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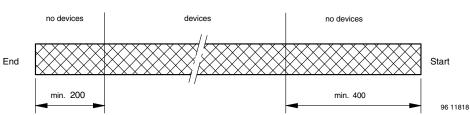


TSOP752.., TSOP754..

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REEL DIMENSIONS in millimeters





COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

Rev. 2.3, 17-May-2024

Datasheet Values Refer to PCN-OPT-1308-2024

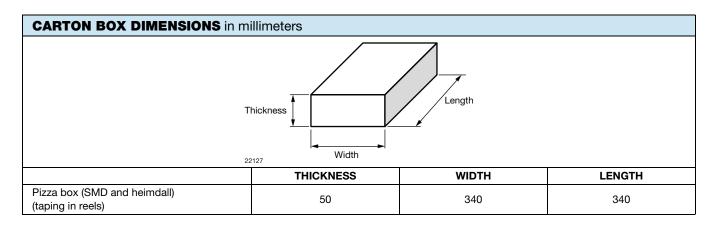


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OUTER PACKAGING

The sealed reel is packed into a pizza box.



LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR Gr	nbH STANDARD BAR CODE PRO	DUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	xxxxxx+	Company logo		
LONG BAR CODE TOP	ТҮРЕ	LENGTH		
Item-number	Ν	8		
Plant-code	Ν	2		
Sequence-number	Х	3		
Quantity	Ν	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH		
Selection-code	Х	3		
Data-code	Ν	3		
Batch-number	Х	10		
Filter	-	1		
Total length	-	17		

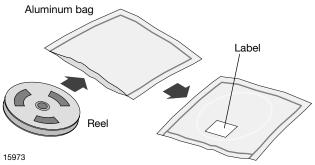
Rev. 2.3, 17-May-2024



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DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

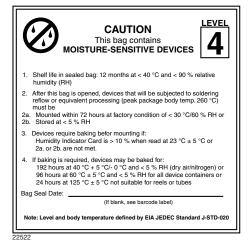
After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or 96 h at 60 °C + 5 °C and < 5 % RH for all device containers

or 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

Rev. 2.3, 17-May-2024

12

Document Number: 82494

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





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